

# High Power Pulsed Laser Diodes 905-Series

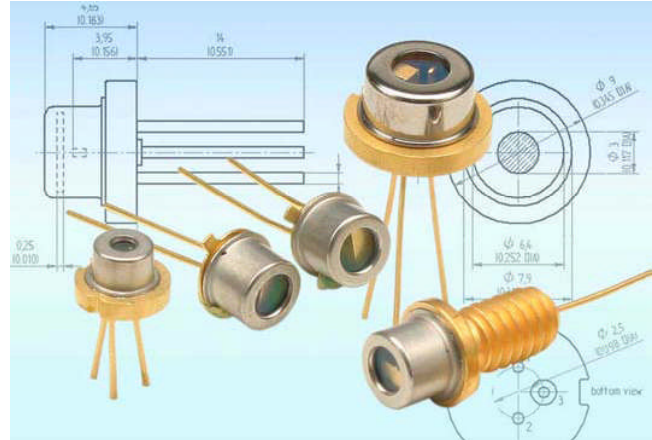
## 25-05702

### FEATURES

- Single and stacked devices up to 130 Watts
- Proven AlGaAs high reliability structure
- 1 W/A efficiency with 25° beam divergence
- Excellent temperature stability
- Hermetic and custom designed package

### APPLICATIONS

- Range finding
- Surveying equipment
- Weapons simulation
- Laser radar
- Security barrier
- Optical trigger



### GENERIC CHARACTERISTICS AT $t_{RT} = 21\text{ }^{\circ}\text{C}$

	Min	Typ	Max	Units
Wavelength of peak radiant intensity $\lambda_m$	895	905	915	nm
Spectral bandwidth $\Delta\lambda$ at 50 % intensity points		5		nm
Wavelength temperature coefficient		0.27		nm/ $^{\circ}\text{C}$
Beam spread (50 % peak intensity)				
Parallel to junction plane $\parallel$		12		Degrees
Perpendicular to junction plane $\perp$				
Single element		25		Degrees
Stacks		30		Degrees



### SINGLE CHIPS

Single chip characteristics at  $t_{RT} = 21^{\circ}\text{C}$ ,  $t_W = 150 \text{ ns}$ ,  $P_{rr} = 6.66 \text{ KHz}$

Parameter	905D1S1.5X	905D1S03X	905D1S06X	905D1S09X	905D1S12X	905D1S16X
$P_O$ at $i_{FM}$ , (min)	3.0 W	6.0 W	13.0 W	19.0 W	26.0 W	34.0 W
Emitting area	37.5 x 1 $\mu\text{m}$	75 x 1 $\mu\text{m}$	150 x 1 $\mu\text{m}$	230 x 1 $\mu\text{m}$	300 x 1 $\mu\text{m}$	400 x 1 $\mu\text{m}$
Max peak forward current $i_{FM}$	3.5 A	7 A	15 A	22 A	30 A	40 A
$I_{th}$ typ	100 mA	200 mA	400 mA	600 mA	800 mA	1200 mA

### STACKED ARRAYS

Stacked chip characteristics at  $t_{RT} = 21^{\circ}\text{C}$ ,  $t_W = 150 \text{ ns}$ ,  $P_{rr} = 6.66 \text{ KHz}$

Parameter	905D2S06X	905D3S09X	905D3S12X	905D4S12X	905D4S16X
Number of elements	2	3	3	4	4
$P_O$ at $i_{FM}$ , (min)	25 W	55 W	70 W	90 W	130 W
Emitting area	150 x 125 $\mu\text{m}$	230 x 225 $\mu\text{m}$	300 x 225 $\mu\text{m}$	300 x 340 $\mu\text{m}$	400 x 340 $\mu\text{m}$
Max peak forward current $i_{FM}$	15 A	22 A	30 A	30 A	40 A
$I_{th}$ typ	400 mA	600 mA	800 mA	800 mA	1200 mA

### ABSOLUTE MAXIMUM RATINGS

Maximum ratings	Limiting values
Peak reverse voltage	6 V
Pulse duration	
Single element	1 $\mu\text{s}$
Stacks	200 ns
Duty factor	0.1 %
Temperature	
Storage	-55 $^{\circ}\text{C}$ to + 100 $^{\circ}\text{C}$
Operating	- 45 $^{\circ}\text{C}$ to + 85 $^{\circ}\text{C}$
Lead soldering	
5 seconds max at	200 $^{\circ}\text{C}$



Figure 1: Optical Output Power vs. Forward Current

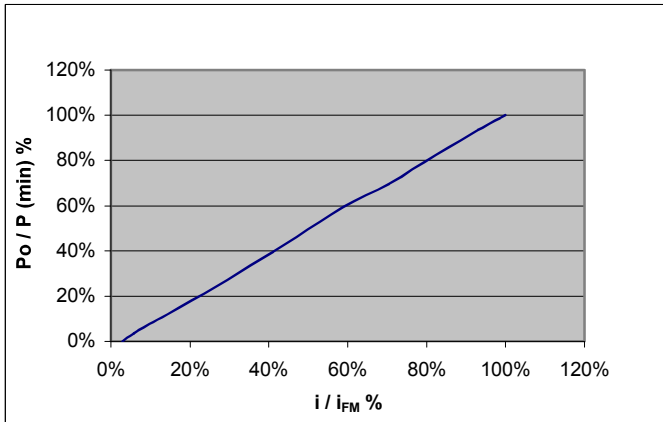


Figure 2: Optical Output Power vs. Temperature

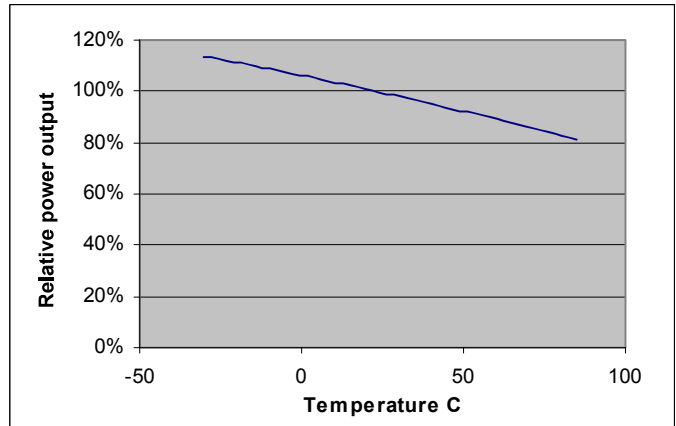


Figure 3: Optical Output Power vs. Half Angle

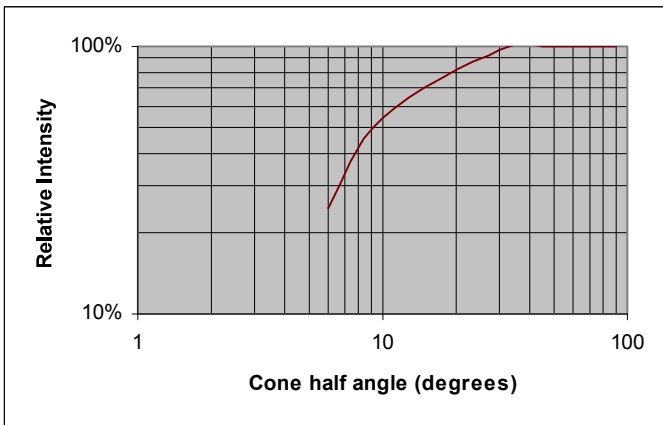


Figure 4: Wavelength vs. Temperature

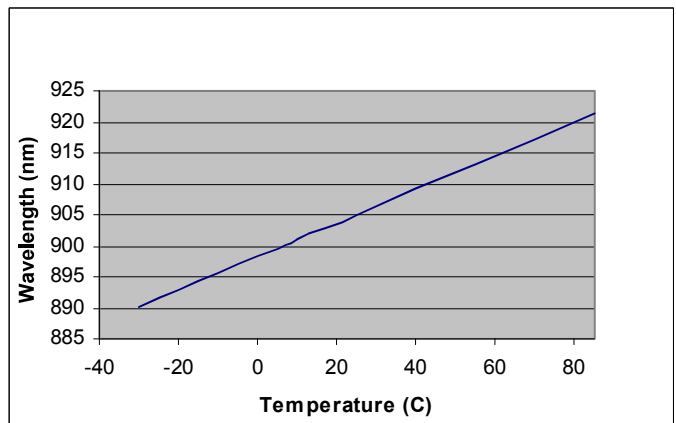


Figure 5: Spectral Plot Distribution

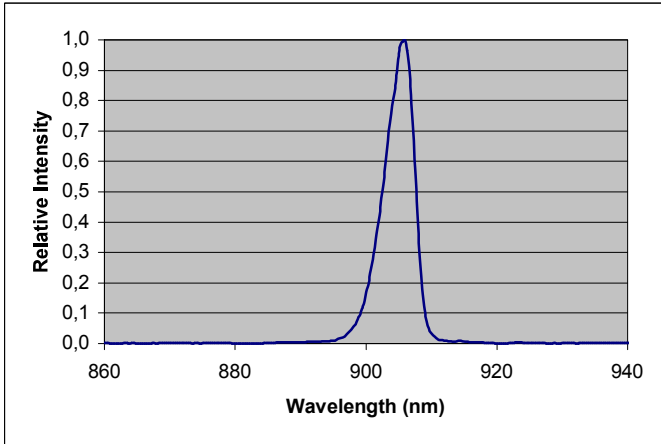
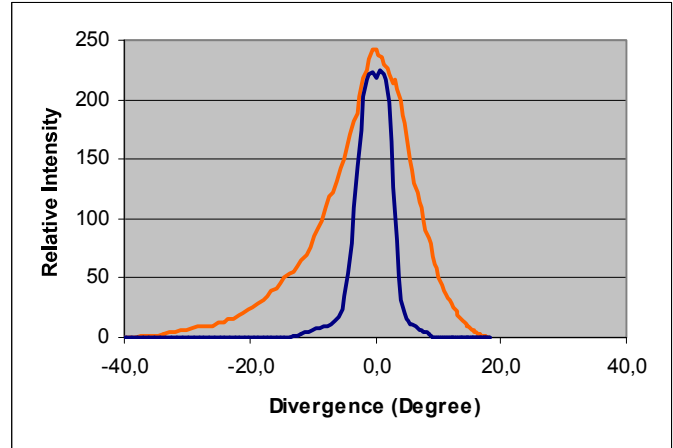
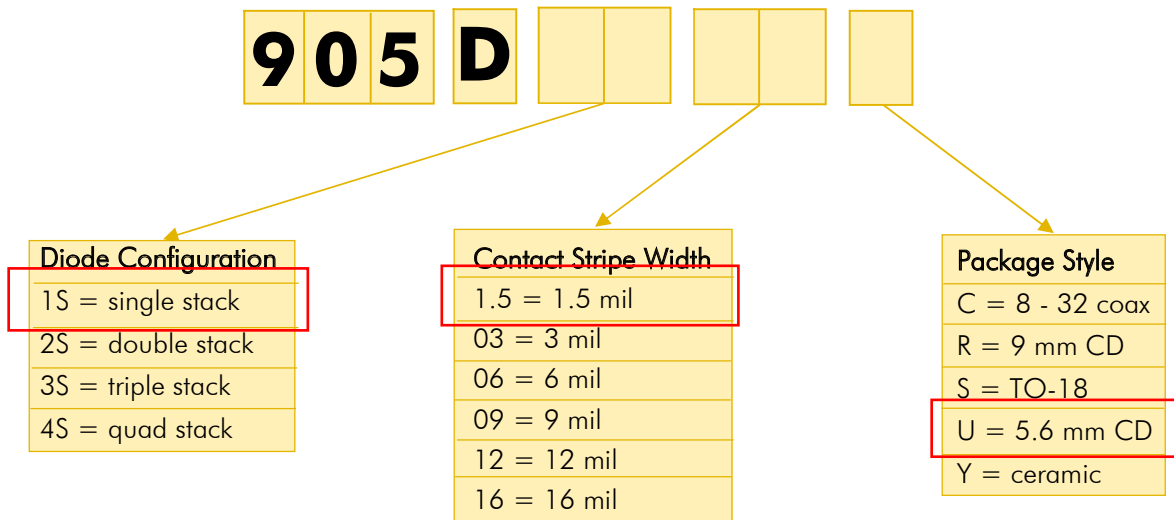


Figure 6: Far Field Emission Pattern Parallel and Perpendicular to Junction Plane

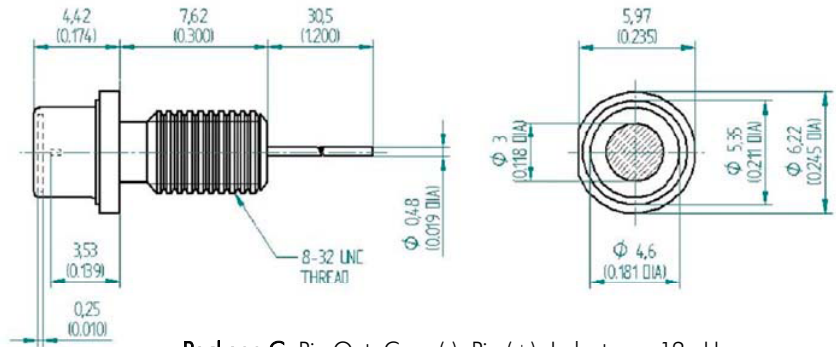


PRODUCT NUMBER DESIGNATION



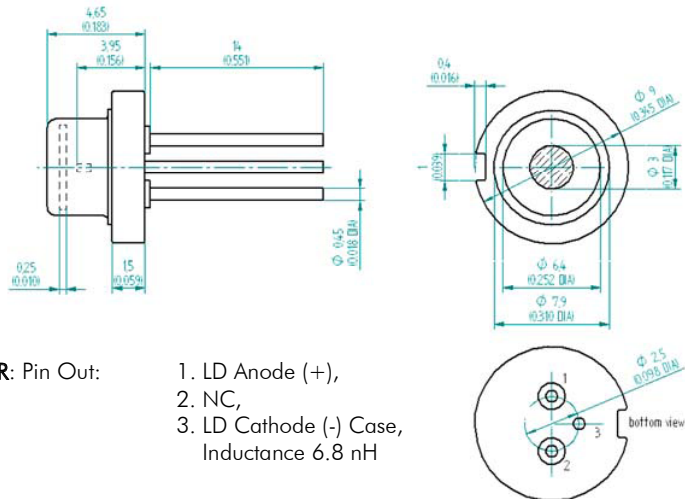
PACKAGE DRAWINGS

Package C 8 – 32 coax



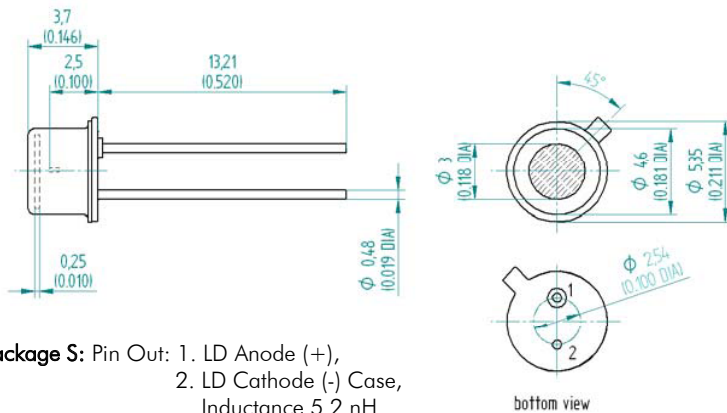
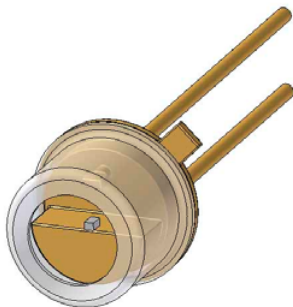
Package C: Pin Out: Case (-), Pin (+), Inductance 12 nH

Package R 9 mm CD



Package R: Pin Out: 1. LD Anode (+), 2. NC, 3. LD Cathode (-) Case, Inductance 6.8 nH

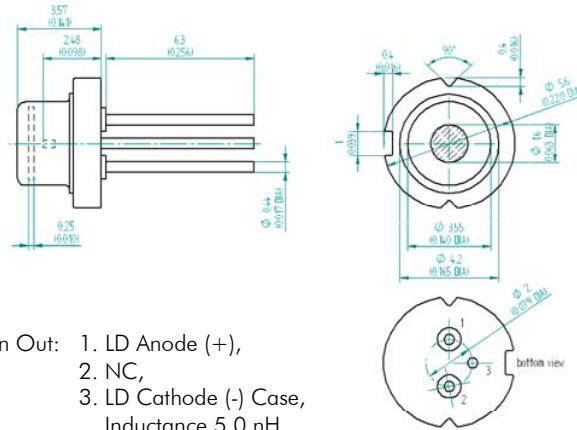
Package S TO-18



Package S: Pin Out: 1. LD Anode (+), 2. LD Cathode (-) Case, Inductance 5.2 nH

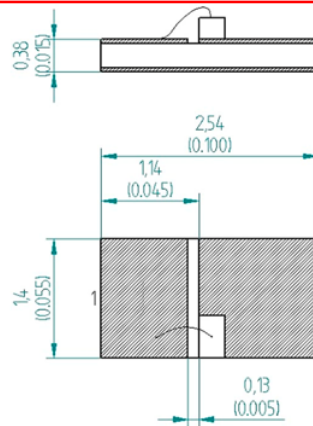
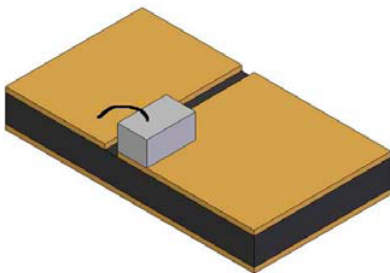


**Package U 5, 6 mm CD**



**Package U:** Pin Out: 1. LD Anode (+),  
2. NC,  
3. LD Cathode (-) Case,  
Inductance 5.0 nH

**Package Y ceramic carrier**



**Package Y:** Pin Out: 1. LD Anode (+), 2. LD Cathode (-), Inductance 1.6 nH

**PRODUCT CHANGES**

LASER COMPONENTS reserves the right to make changes to the product(s) or information contained herein without notice. No liability is assumed as a result of their use or application.

**ORDERING INFORMATION**

Products can be ordered directly from LASER COMPONENTS or its representatives. For a complete listing of representatives, visit our website at [www.lasercomponents.com](http://www.lasercomponents.com)  
Custom designed products are available on request.

**LASER SAFETY**

**Personal Hazard:**

Depending on the mode of operation, these devices emit highly concentrated non visible infrared light which can be hazardous to the human eye. Products which incorporate these devices have to follow the safety precautions given in IEC 60825-1 "Safety of laser products".

**Handling Precautions:**

Products are subject to the risks normally associated with sensitive electronic devices including static discharge, transients, and overload.

